

Dual Buffer

General Description

The ET74AUP2G34 is a high-performance dual buffer operating from a 0.8V to 3.6V supply. This device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive.

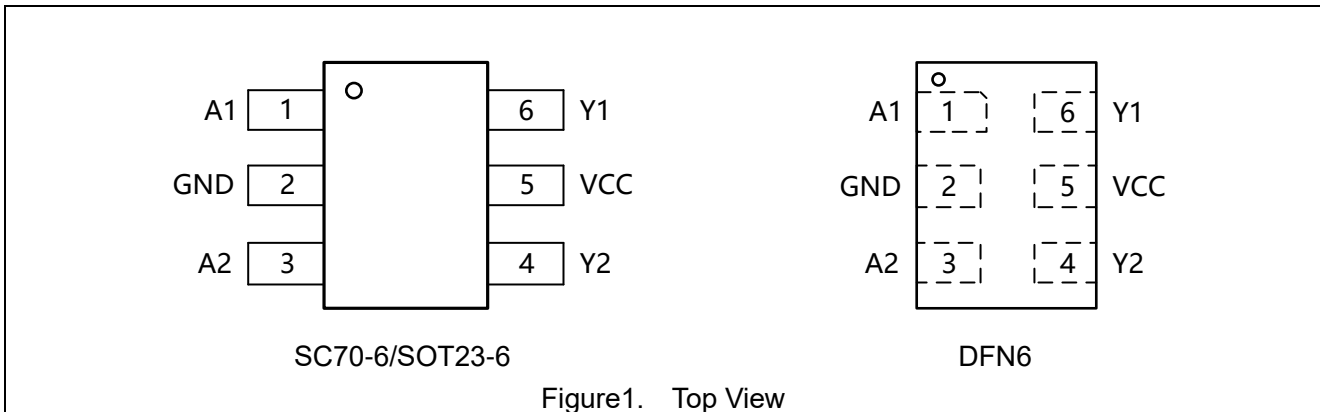
Features

- Designed for 0.8V to 3.6V VCC Operation
- Low static power consumption; ICC = 0.7μA (maximum)
- 4mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current Substantially Reduces System Power Requirements
- These Devices are Pb-Free and are RoHS Compliant

Device Information

Part No.	Package	Packing Option	MSL
ET74AUP2G34	SC70-6 (1.3mm×2.1mm)	Tape and Reel, 3K	1
ET74AUP2G34T	SOT23-6 (1.6mm×2.9mm)	Tape and Reel, 3K	3
ET74AUP2G34Y	DFN6 (1.0mm×1.5mm)	Tape and Reel, 3K	1

Pin Configuration



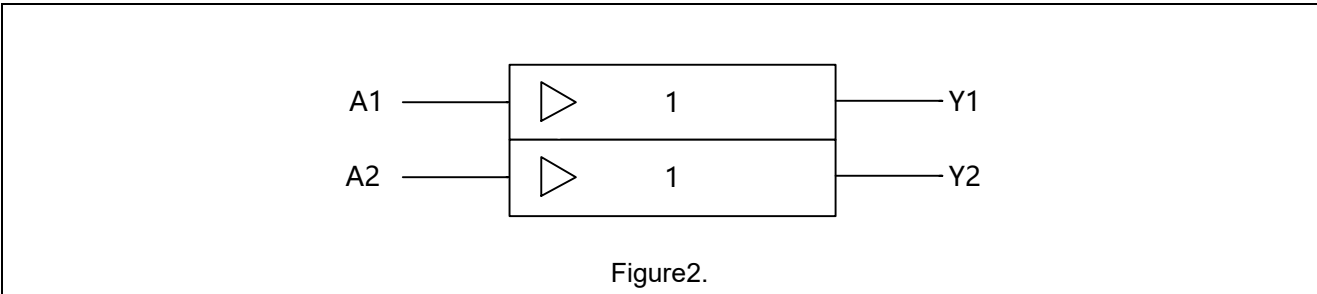
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Pin Function

SC70-6/ SOT23-6/DFN6

Pin No.	Pin Name	Function
1	A1	Input CH1
2	GND	Ground
3	A2	Input CH2
4	Y2	Output CH2
5	VCC	Supply Voltage
6	Y1	Output CH1

Block Diagram



Functional Description

Function Table

Input A	Output Y
H	H
L	L

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Absolute Maximum Ratings

Symbol	Parameter		Value	Unit
V _{CC}	DC Supply Voltage		−0.5 to 4.6	V
V _I	DC Input Voltage		−0.5 ≤ V _I ≤ +4.6	V
V _O	DC Output Voltage Output in Higher or Low State ⁽¹⁾		−0.5 to 4.6	V
I _{IK}	DC Input Diode Current	V _I < GND	−50	mA
I _{OK}	DC Output Diode Current	V _O < GND, V _O > V _{CC}	±50	mA
I _O	DC Output Sink Current		±20	mA
I _{CC}	DC Supply Current per Supply Pin		±50	mA
I _{GND}	DC Ground Current per Supply Pin		±50	mA
T _{STG}	Storage Temperature Range		−65 to 150	°C
T _L	Lead Temperature, Soldering 10 Seconds		260	°C
T _J	Max Junction Temperature		150	°C
V _{ESD}	ESD Classification	Human Body Model ⁽²⁾	±4000	V
		Charged Device Model ⁽³⁾	±1000	
I _{LU}	Max Latch up Current Above V _{CC} and GND at 125°C ⁽⁴⁾		±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Notes: 1. IO absolute maximum rating must be observed.

2. Tested to EIA/JESD22-A114-A.

3. Tested to JESD22-C101-A.

4. Tested to EIA/JESD78.

Thermal Characteristics

Symbol	Package	Ratings	Value	Unit
R _{θJA}	SC70-6	Thermal Characteristics, Thermal Resistance, Junction-to-Air	280	°C/W
	SOT23-6		180	
	DFN6(1.0×1.5)		440	
P _D	SC70-6	Power Dissipation in Still Air at 85°C	230	mW
	SOT23-6		360	
	DFN6(1.0×1.5)		150	

Recommended Operating Conditions

Symbol	Parameter		Min	Max	Unit
V _{CC}	DC Supply Voltage Operating		0.8	3.6	V
V _{IN}	DC Input Voltage		0	3.6	V
V _{OUT}	DC Output Voltage (High or Low State)		0	3.6	V
T _A	Operating Temperature Range		−40	85	°C
t _r , t _f	Input Rise and Fall Time	V _{CC} = 0.8V to 3.6V	0	20	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied.

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Electrical Characteristics

DC Electrical Characteristics

Symbol	Parameter	Condition	V _{CC} (V)	T _A = 25°C			-40°C ≤ T _A ≤ 85°C		Unit
				Min	Typ	Max	Min	Max	
V _{IH}	High-Level Input Voltage		0.8	0.75V _{CC}			0.75V _{CC}		V
			0.9 to 1.95	0.7V _{CC}			0.7V _{CC}		
			2.3 to 2.7	1.6			1.6		
			3.0 to 3.6	2.0			2.0		
V _{IL}	Low-Level Input Voltage		0.8			0.25V _{CC}		0.25V _{CC}	V
			0.9 to 1.95			0.3V _{CC}		0.3V _{CC}	
			2.3 to 2.7			0.7		0.7	
			3.0 to 3.6			0.9		0.9	
V _{OH}	High-Level Output Voltage	I _{OH} = -20μA	0.8 to 3.6	V _{CC} -0.1			V _{CC} -0.1		V
		I _{OH} = -1.1mA	1.1	0.82	1.02		0.77		
		I _{OH} = -1.7mA	1.4	1.11	1.32		1.03		
		I _{OH} = -1.9mA	1.65	1.32	1.58		1.30		
		I _{OH} = -2.3mA	2.3	2.05	2.24		1.97		
		I _{OH} = -3.1mA		1.9	2.22		1.85		
		I _{OH} = -2.7mA	3.0	2.72	2.95		2.67		
		I _{OH} = -4.0mA		2.6	2.92		2.55		
V _{OL}	Low-Level Output Voltage	I _{OL} = 20μA	0.8 to 3.6			0.1		0.1	V
		I _{OL} = 1.1mA	1.1		0.11	0.33		0.33	
		I _{OL} = 1.7mA	1.4		0.12	0.31		0.37	
		I _{OL} = 1.9mA	1.65		0.11	0.31		0.35	
		I _{OL} = 2.3mA	2.3		0.14	0.31		0.33	
		I _{OL} = 3.1mA			0.19	0.44		0.45	
		I _{OL} = 2.7mA	3.0		0.11	0.31		0.33	
		I _{OL} = 4.0mA			0.16	0.44		0.45	
I _{IN}	Input Leakage Current	V _{IN} = V _{CC} or GND	0 to 3.6			±0.1		±0.2	μA
I _{OFF}	Power Off Leakage Current	V _{IN} = 3.6 V or V _{OUT} = 3.6 V	0			±0.2		±0.5	μA
I _{CC}	Quiescent Supply Current	V _{IN} = 3.6V or GND	3.6			±0.2		±0.7	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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AC Electrical Characteristics

$t_r = t_f = 2.5\text{ns}$

Symbol	Parameter	Condition	V _{CC} (V)	T _A = 25°C			-40°C ≤ T _A ≤ 85°C		Unit
				Min	Typ	Max	Min	Max	
t _{PLH} t _{PHL}	Propagation Delay (Figure3 And 4)	C _L = 5 pF ⁽⁵⁾	0.8	13.2	29	90.1	11.9	220	ns
			1.2	5.0	7.6	14.3	4.6	14.4	
			1.5	3.4	4.8	8.9	3	9.6	
			1.8	2.7	3.6	6.9	2.3	7.6	
			2.5	1.9	2.4	5.1	1.6	5.6	
			3.3	1.5	1.9	4.4	1.3	4.8	
		C _L = 10 pF ⁽⁵⁾	0.8	14.3	31.3	97.9	12.8	239	ns
			1.2	5.4	8.3	15.3	5.0	15.3	
			1.5	3.7	5.2	9.5	3.2	10.2	
			1.8	2.9	3.9	7.4	2.5	8.1	
			2.5	2.0	2.6	5.4	1.7	6.0	
			3.3	1.6	2.0	4.6	1.3	5.1	
		C _L = 15 pF ⁽⁵⁾	0.8	15.3	32.5	106	13.8	259	ns
			1.2	5.8	8.9	16.3	5.3	16.3	
			1.5	4.0	5.6	10.1	3.5	10.9	
			1.8	3.1	4.2	7.8	2.6	8.6	
			2.5	2.1	2.8	5.8	1.8	6.4	
			3.3	1.7	2.2	4.9	1.4	5.4	
		C _L = 30 pF ⁽⁵⁾	0.8	18.3	37.5	130	16.6	323	ns
			1.2	7.0	10.7	19.3	6.4	19.3	
			1.5	4.8	6.9	12.0	4.2	12.9	
			1.8	3.7	5.1	9.2	3.2	10.2	
			2.5	2.6	3.5	6.7	2.2	7.5	
			3.3	2.0	2.2	5.6	1.7	6.3	

Note5. C_L includes probe and jig capacitance.

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Capacitance Characteristics

Symbol	Parameter	Condition		Typical	Unit
C _{IN}	Input Capacitance	V _{CC} = 3.6V, V _I = 0 V or V _{CC}		2	pF
C _O	output capacitance	V _{CC} = 0V, V _{OUT} = GND		3	pF
C _{PD}	Power Dissipation Capacitance ⁽⁶⁾	1 MHz, V _I = 0 V to V _{CC}	V _{CC} = 0.8V	7.6	pF
			V _{CC} = 1.2V	8.1	
			V _{CC} = 1.5V	8.5	
			V _{CC} = 1.8V	8.6	
			V _{CC} = 2.5V	9.0	
			V _{CC} = 3.3 V	9.6	

Note6. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: $I_{CC(OPR)} = C_{PD} \times V_{CC} \times f_{in} + I_{CC} \times C_{PD}$ is used to determine the no-load dynamic power consumption; $P_D = C_{PD} \times V_{CC}^2 \times f_{in} + I_{CC} \times V_{CC} \times Fig.$

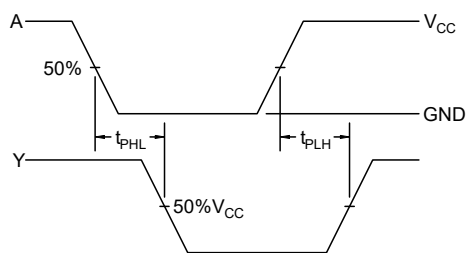


Figure 3. Switching Waveforms

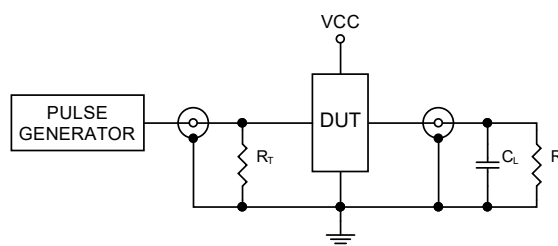
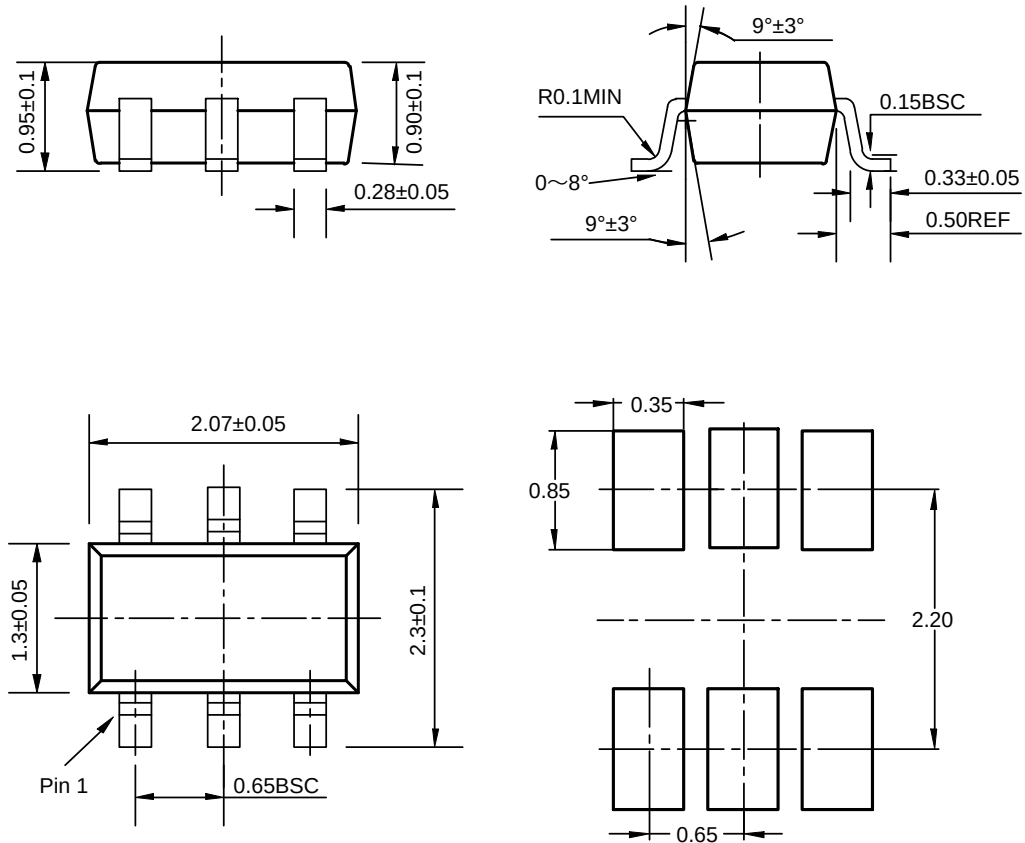


Figure 4. Test Circuit

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Package Dimension

SC70-6

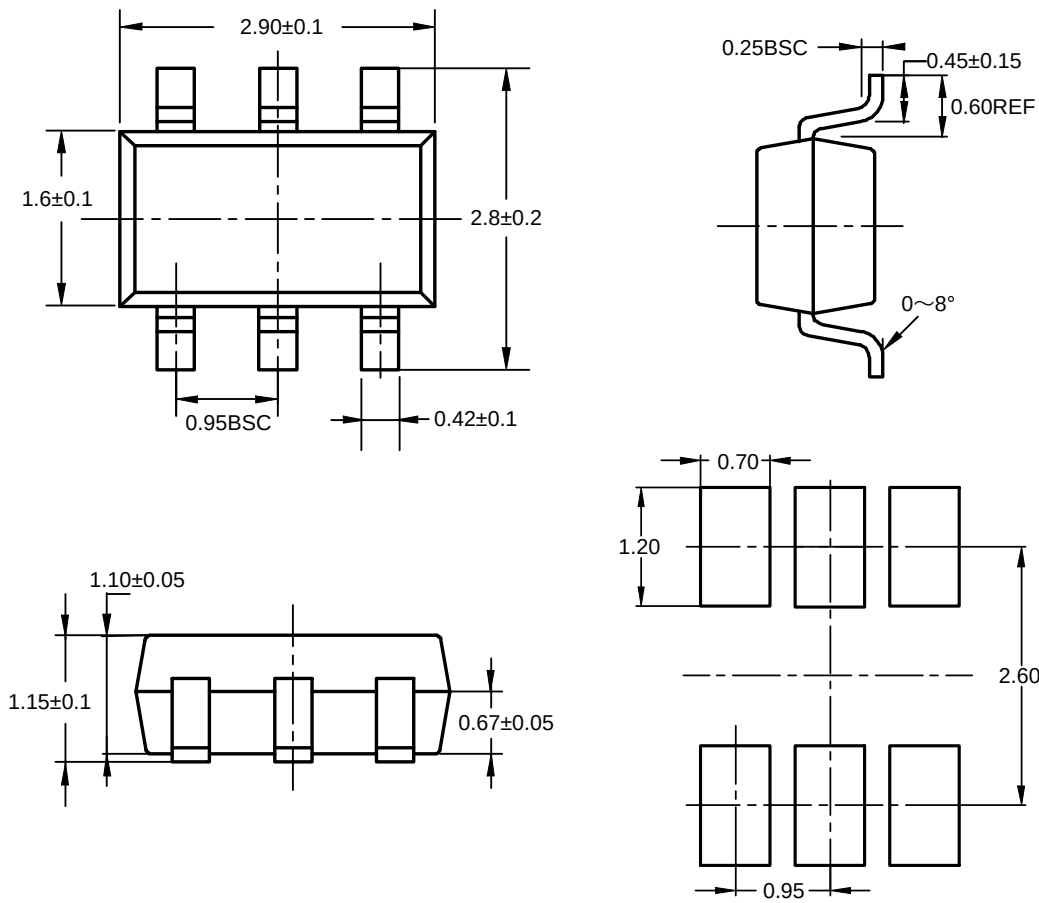


Recommended Land Pattern

Unit: mm

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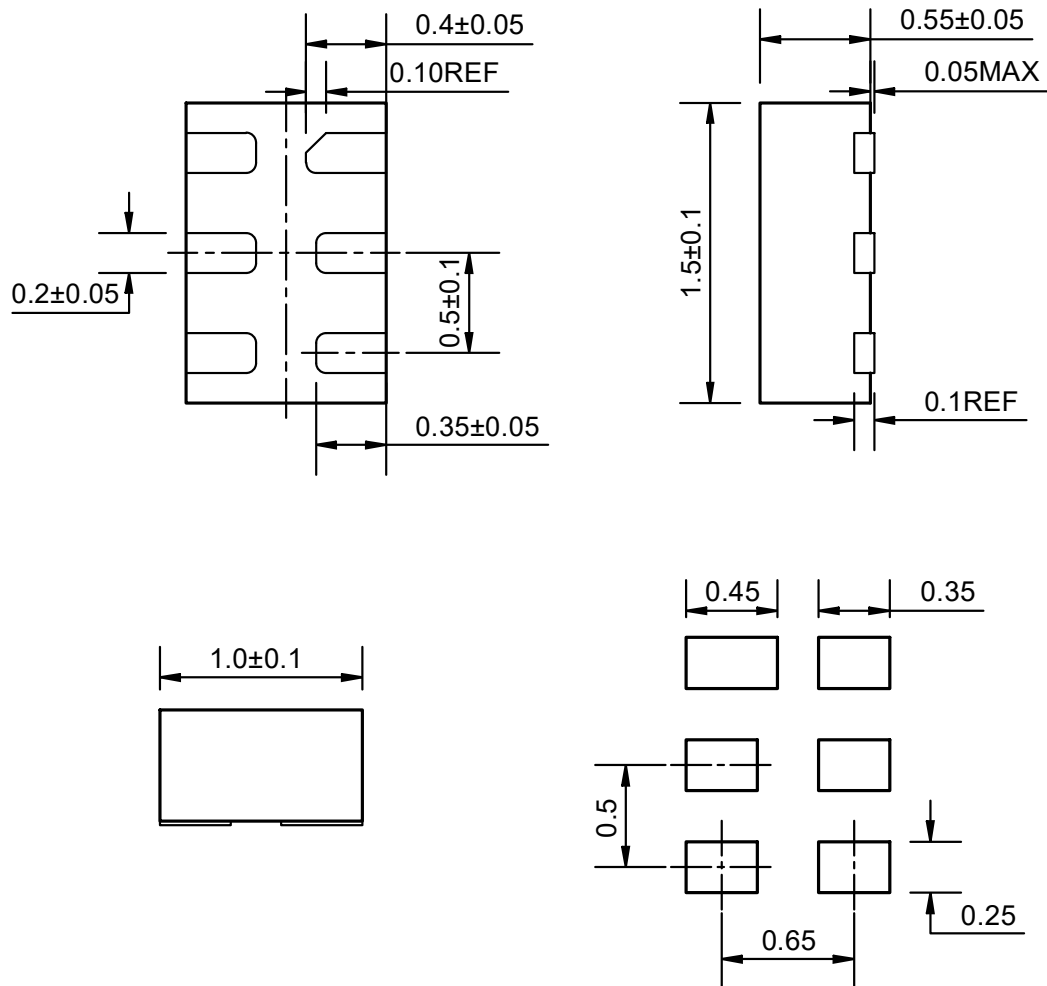
SOT23-6



Unit: mm

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DFN6



Recommended Land Pattern

Unit: mm

Revision History and Checking Table

Version	Date	Revision Item	Modifier	Function & Spec Checking	Package & Tape Checking
1.0	2023-11-28	Initial Version	Shibo	Luh	Liu jy
1.1	2023-11-29	Update Typeset /ESD	Shibo	Shibo	Shibo
1.2	2025-06-05	Add Packing Option	Yang xiaoxu	Yang xiaoxu	Liu jiaying